2-825440-5 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 2-825440-5 PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **50**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No

Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	50
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 Vrms
Body Features	
Primary Product Color	Green
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]

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PCB Contact Termination Area Plating Material Thickness	2.5 μm			
Contact Shape & Form	Square			
Contact Underplating Material	Nickel			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Brass			
Contact Mating Area Plating Material	Gold or Gold Flash over Palladium Nickel			
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]			
Contact Type	Pin			
Contact Current Rating (Max)	5 A			
Termination Features				
Square Termination Post & Tail Dimension	.64 mm[.025 in]			
Termination Post & Tail Length	3.2 mm[.126 in]			
Termination Method to Printed Circuit Board	Through Hole - Solder			
Mechanical Attachment				
Mating Alignment	Without			
PCB Mount Retention	Without			
PCB Mount Alignment	Without			
Connector Mounting Type	Board Mount			
Housing Features				
Centerline (Pitch)	2.54 mm[.1 in]			
Housing Material	PBT			
Dimensions				
Row-to-Row Spacing	2.54 mm[.1 in]			

1.57 mm[.062 in]

-65 – 105 °C[-85 – 221 °F]

Standard

Signal

UL 94V-0

C For support call+1 800 522 6752

PCB Thickness (Recommended)

Housing Temperature Rating

Operating Temperature Range

Usage Conditions

Operation/Application

Circuit Application

UL Flammability Rating

Industry Standards

Packaging Features

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Packaging Quantity	200
Packaging Type	Carton
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

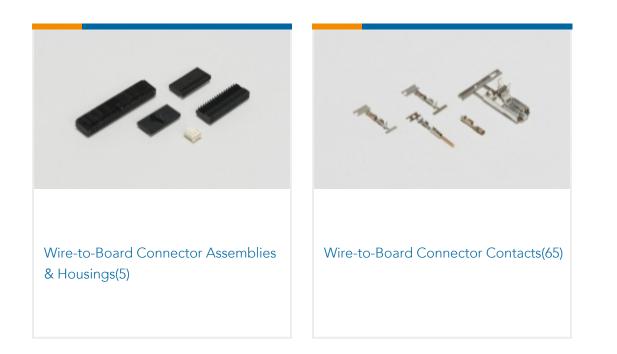
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Also in the Series AMPMODU Headers



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Customers Also Bought



2X25P HV100 REC CON. TE, 7.0MM	8P AMP-QUICK STLEI	STVF 32 M ZB GG 3-00 ZD * * 207 E	STVC/2 48 M ABC VVV 4-00 EE * * 247	
		016 *	E007	

Documents

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_2-825440-5_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_2-825440-5_F.3d_igs.zip

English

Customer View Model

ENG_CVM_2-825440-5_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

TE Material Declaration

English

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Agency Approvals UL Report

English